

Inventor(s): Lai, et al
Serial No.: To Be Assigned
Filed: Herewith
For: Method Of Wet Etching Low Dielectric Constant Materials
Attorney Docket No.: 67,200-473

1/5

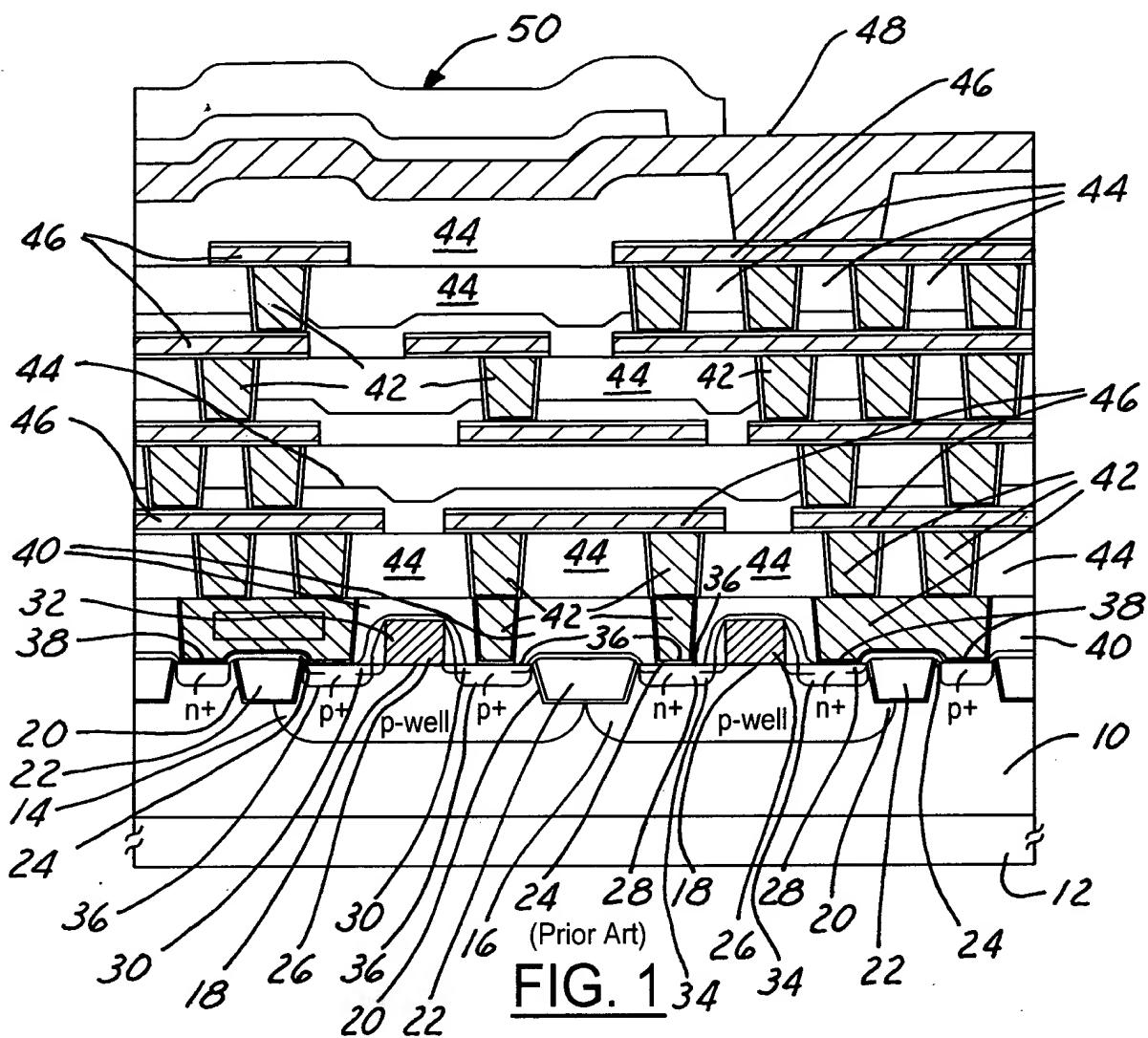


FIG. 1

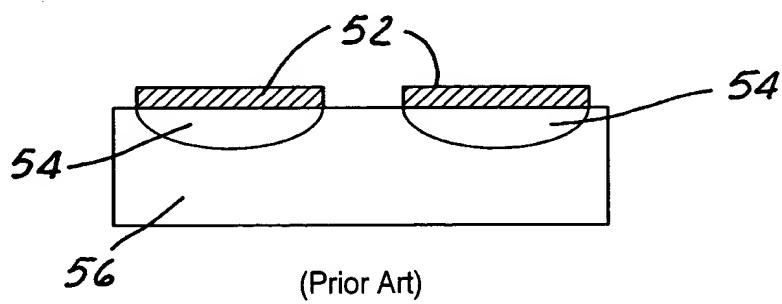
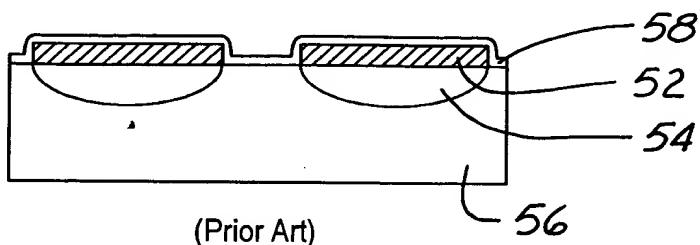
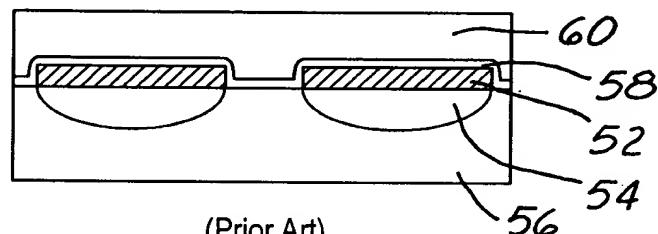


FIG. 2A



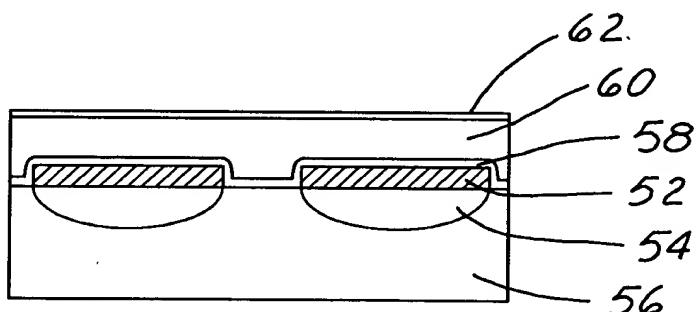
(Prior Art)

FIG. 2B



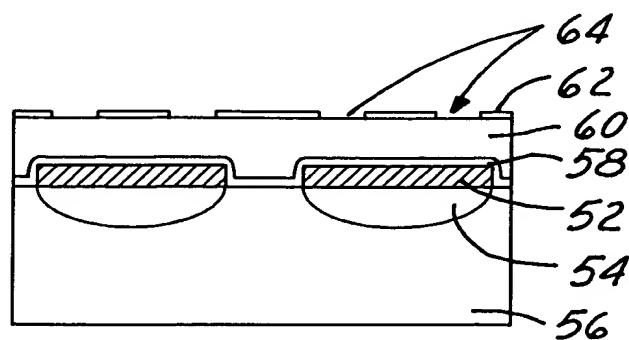
(Prior Art)

FIG. 2C



(Prior Art)

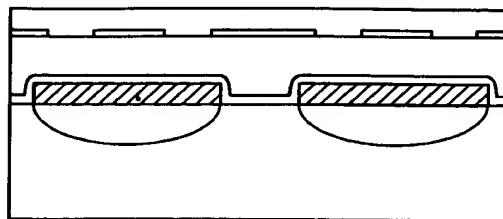
FIG. 2D



(Prior Art)

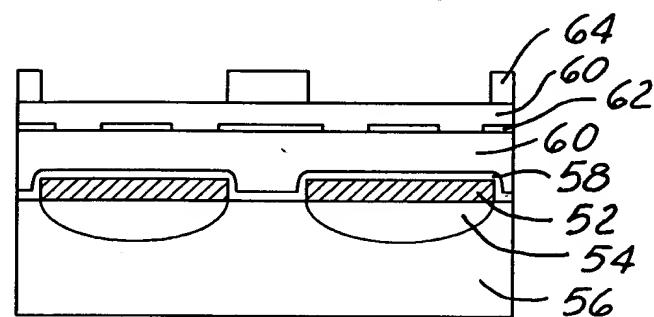
FIG. 2E

09/941,355 - 08/29/01



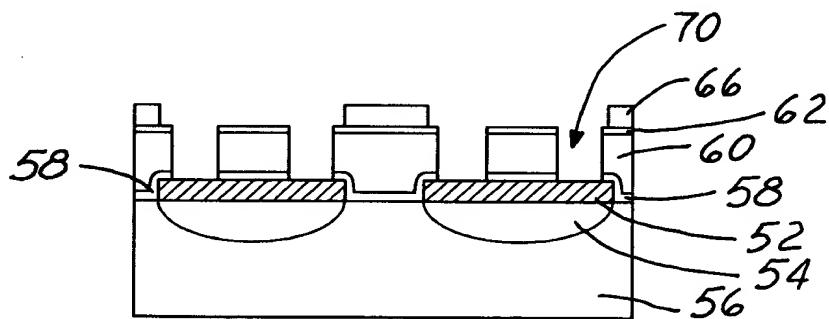
(Prior Art)

FIG. 2F



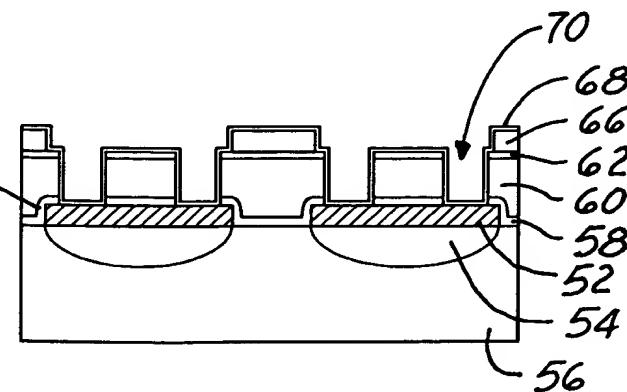
(Prior Art)

FIG. 2G



(Prior Art)

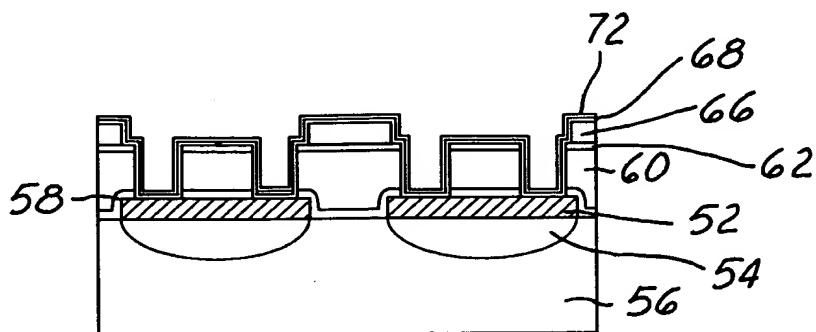
FIG. 2H



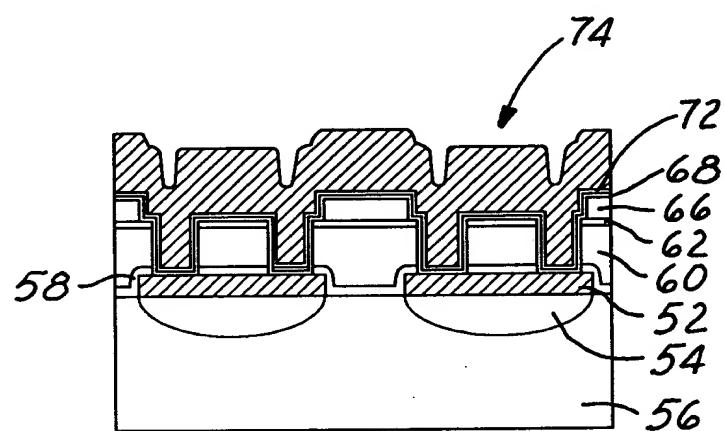
(Prior Art)

FIG. 2I

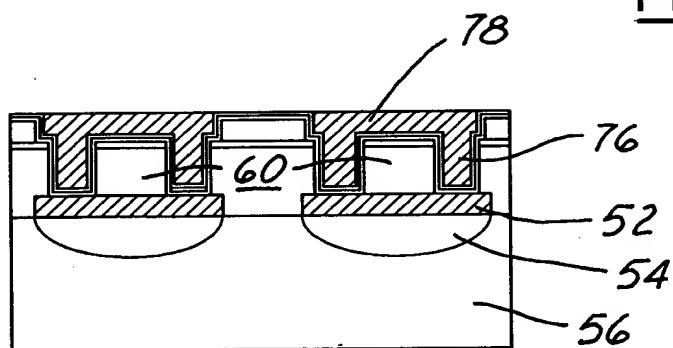
05541356 - 082901



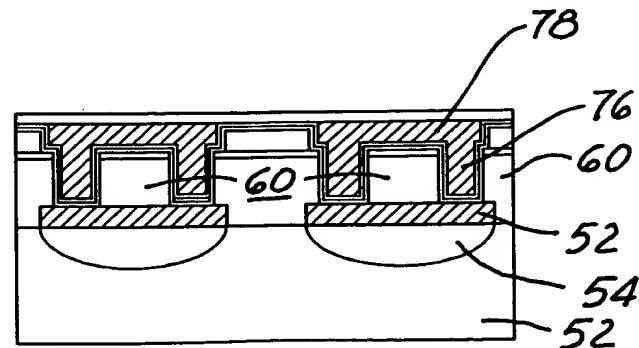
(Prior Art)
FIG. 2J



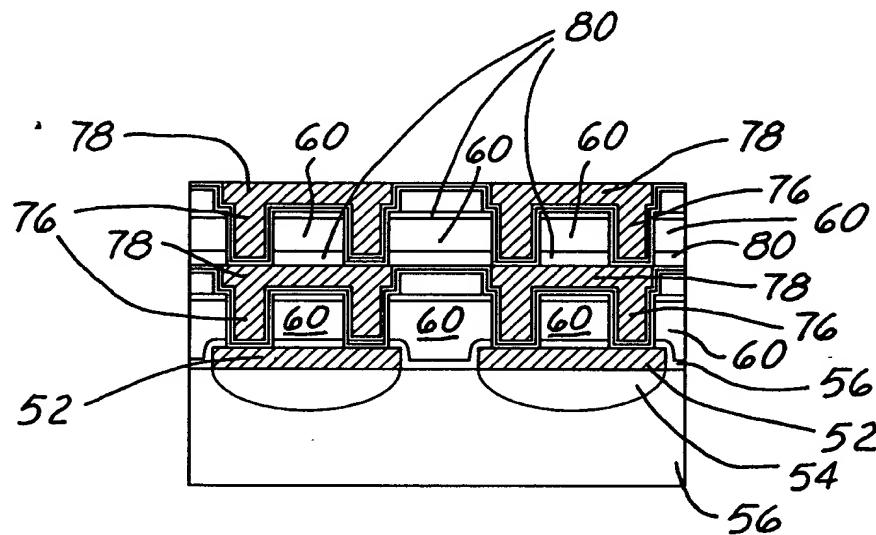
(Prior Art)
FIG. 2K



(Prior Art)
FIG. 2L



(Prior Art)
FIG. 2M



(Prior Art)

FIG. 2N

RECORDED - DECEMBER 10, 1998

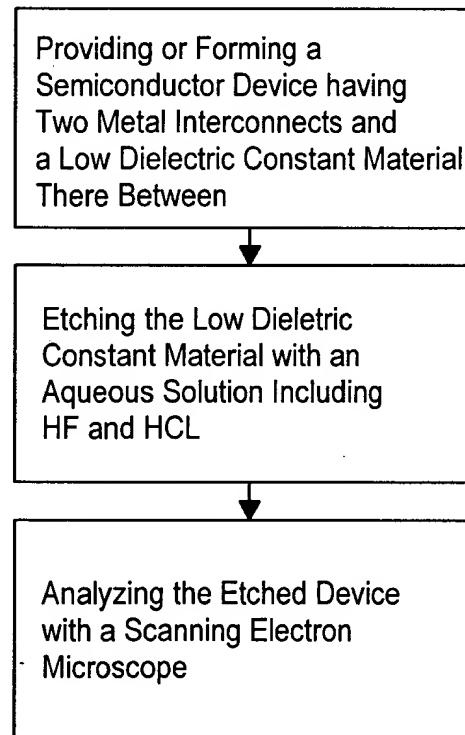


FIG. 3